

# Model Name: P586ZVN01.0

Issue Date: 2025/05/28

( )Preliminary Specifications (\*)Final Specifications

Customer Sigr	nature	Date	AUO	Date
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Note		Pl	Reviewed By RD Director Lamy Chen	
			Reviewed By Project Leader Simon Chuang	
	For,		Prepared By PM Kim Kuo	



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### **Record of Revision**

/ersion	Date	Page	n Description
1.0	2023/05/10	All	First Version Released
		4	Update special material
1.1	2023/09/11	34	Update carton label
	1	38	Update operation temperature
	(	4	Update General Description: from 8-bit to 10-bit gray scale signal
		6	Update Absolute Maximum Ratings Chart
4.0	0004/05/00	7	Update Optical Spec. Color Coordinates
1.2	2024/05/09	25	Update Backlight Spec. LED MTTF 50,000 from Min. to Typ.
		32	Update Reliability Test Items drop test height condition
		37	Update Pallet and Shipment Information
1.3	2025/5/28	4,5	Revise LED MTTF to MTBF:100Khours, and Note 3 description
		32	Add MTBF test items in Chapter 8 Reliability Test Items
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### 1. General Description

This specification applies to the 58.6 inch Color TFT-LCD Module P586ZV01.0 This LCD module has a TFT active matrix type liquid crystal panel 5120 x 1440 pixels, and diagonal size of 58.6 inch. This module supports I 5120 x 1440 mode. Each pixel is divided into Red, Green and Blue sub-pixels or dots which are arranged in vertical stripes. Gray scale or the brightness of the sub-pixel color is determined with a 10-bit scale signal for each dot.

P586ZV01.0 has been designed to apply eDP interface method. It is intended to support displays where high brightness, wide viewing angle, high color saturation, and high color depth are very important.

Special material applied into this model are:

- 1. Liquid crystal: Advanced wide temperature LC(-40°C ~110°C)
- 2. Polarizer: Wide temperature polarizer (95°C)

#### \* General Information

General Information					
Items	Specification	Unit	Note		
Active Screen Size	58.6	inch			
Display Area	1431.71 (H) x 402.67 (V)	mm			
Outline Dimension	1459.51(H) x 430.47(V) x 27(D)	mm	D: front bezel to wall mount		
Driver Element	a-Si TFT active matrix				
Display Colors	8 bit + FRC	Colors			
Number of Pixels	5120 *1440	Pixel			
Pixel Pitch	0.279 (H) x 0.279 (W)	mm			
Pixel Arrangement	RGB vertical stripe	h	; al		
Display Operation Mode	Normally Black	e yeu	anly		
Surface Treatment	Anti-Glare 28%	16	2		
Rotate Function	Unachievable	103	Note 1		
Display Orientation	Portrait/Landscape Enabled	24	Note 2		
Operating Time	24/7	70.	See Chapter 11.3 for details		
Frame Rate	60	Hz	See Chapter 5.1 for details		
MTBF	100K	hours	See Chapter 8 for details Note 3		

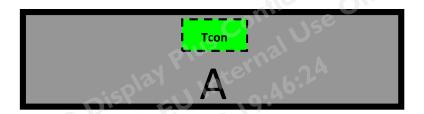


Note 1: Rotate Function refers to LCD display could be able to rotate. This function does not work in this model.

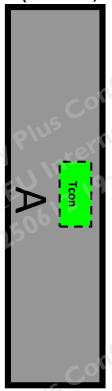
#### Note 2:

- (1) Landscape Mode: The default placement is T-Con Side on the upper side and the image is shown upright via viewing from the front.
- (2) Portrait Mode: The default placement is that T-Con side has to be placed on the right side via viewing from the front.

#### Landscape (Front view)



#### Portrait (Front view)



**Note 3:** MTBF is a reference index, it is not representative of warranty. Thermal acceleration factor based on Arrhenius model with eV = 0.6 @ Ambient temp 25C/50%



### 2. Absolute Maximum Ratings

The followings are maximum values which, if exceeded, may cause faulty operation or damage to the unit

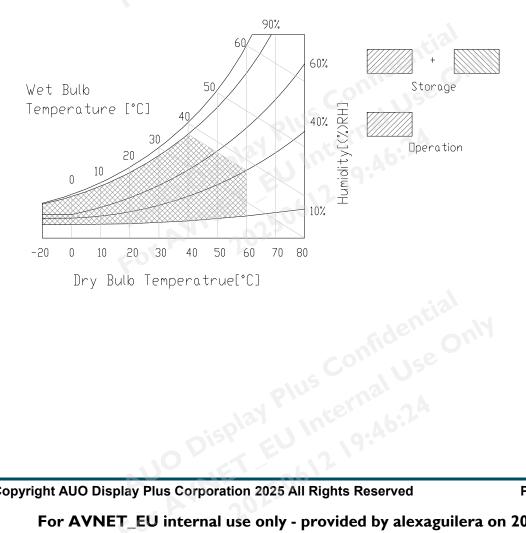
Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	V <sub>DD</sub>	-0.3	14	[Volt]	Note 1
Input Voltage of Signal	Vin	-0.3	4	[Volt]	Note 1
Operating Temperature	TOP	-20	60	[°C]	Note 2
Operating Humidity	HOP	10	90	[%RH]	Note 2
Storage Temperature	TST	-20	+60	[°C]	Note 2
Storage Humidity	HST	10	90	[%RH]	Note 2
Panel Surface Temperature	PST		65	[°C]	Note 3

Note 1: Duration:50 msec.

Note 2: Maximum Wet-Bulb should be 39 °C and No condensation.

The relative humidity must not exceed 90% non-condensing at temperatures of 40°C or less. At temperatures greater than 40°C, the wet bulb temperature must not exceed 39 °C.

Note 3: Surface temperature is measured at 60 °C Dry condition

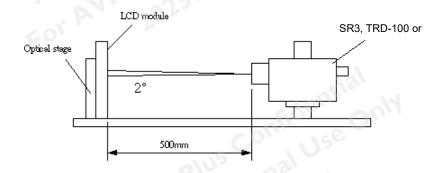




### 3. Optical Specification

Optical characteristics are determined after the unit has been 'ON' and stable for approximately 45 minutes in a dark environment at 25°C. The values specified are at an approximate distance 500 mm from the LCD surface at a viewing angle of  $\phi$  and  $\theta$  equal to  $0^{\circ}$ .

Fig.1 presents additional information concerning the measurement equipment and method.



	Parameter		7 ///	Values		1 lm:4	Notes
	Parameter	Symbol	Min.	Тур.	Max	Unit	Notes
Contra	Contrast Ratio		3200	4000			1
Surface	e Luminance (White)	Lwh	560	700		cd/m <sup>2</sup>	2
Lumina	ance Variation	δwнite(9P)			1.33		3
Respoi	nse Time (G to G)	Тү		16	24	ms	4
Color C	Gamut	NTSC	67.5	72	- 11	%	
Gamm	a	Gma	1.9	2.2	2.5		
Color C	Coordinates		2 C C	1056			
	Red	R <sub>X</sub>		0.650			
		Ry	· Inte	0.337			
	Green	Gx	0 . 1	0.325			
	700	Gy	T 0.00	0.611	T 0 00		
	Blue	B <sub>X</sub>	Typ0.03	0.153	Typ.+0.03		
	604	B <sub>Y</sub>		0.077			
	White	Wx		0.313			
		W <sub>Y</sub>		0.329	2)		
Viewin	g Angle			ege	Oull		5
	x axis, right(φ=0°)	$\theta_{r}$	85	89		degree	
	x axis, left(φ=180°)	θι	85	89		degree	
	y axis, up(φ=90°)	$\theta_{u}$	85	89		degree	
	y axis, down (φ=270°)	$\theta_{\sf d}$	85	89		degree	



Note:

1. Contrast Ratio (CR) is defined mathematically as:

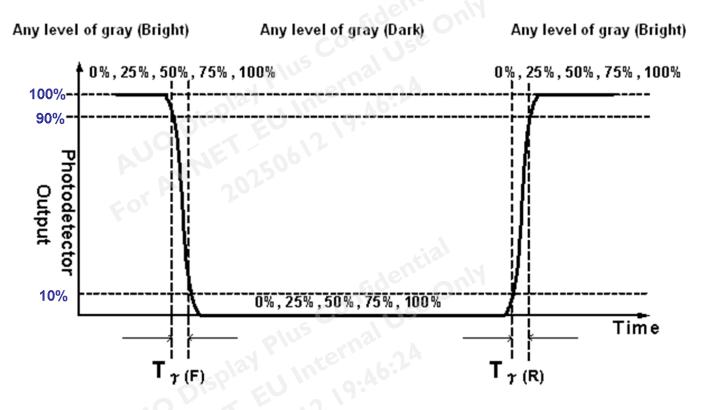
- 2. Surface luminance is luminance value at point 5 across the LCD surface 50cm from the surface with all pixels displaying white. From more information see FIG 2. LED current I<sub>F</sub> = typical value (without driver board), LED input VDDB =24V, IDDB. = Typical value (with driver board), LwH=Lon5 where Lon5 is the luminance with all pixels displaying white at center 5 location.
- 3. The variation in surface luminance, δWHITE is defined (center of Screen) as:  $\delta_{WHITE(9P)}$ = Maximum( $L_{on1}$ ,  $L_{on2}$ ,..., $L_{on9}$ )/ Minimum( $L_{on1}$ ,  $L_{on2}$ ,... $L_{on9}$ )
- Response time Ty is the average time required for display transition by switching the input signal for five luminance ratio (0%,25%,50%,75%,100% brightness matrix) and is based on Frame rate = 60Hz to optimize.

Mea	asured		olus	Target		
Respo	nse Time	0%	25%	50%	75%	100%
	0%	06	0% to 25%	0% to 50%	0% to 75%	0% to 100%
	25%	25% to 0%		25% to 50%	25% to 75%	25% to 100%
Start	50%	50% to 0%	50% to 25%		50% to 75%	50% to 100%
	75%	75% to 0%	75% to 25%	75% to 50%		75% to 100%
	100%	100% to 0%	100% to 25%	100% to 50%	100% to 75%	

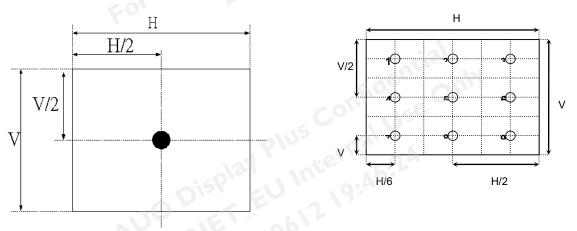
T<sub>Y</sub> is determined by 10% to 90% brightness difference of rising or falling period. (As illustrated)

. ડnall be mea The response time is defined as the following figure and shall be measured by switching the input signal for "any level of gray(bright) " and "any level of gray(dark)".





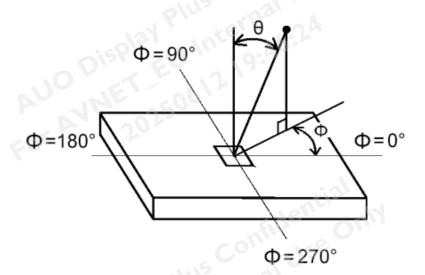
#### FIG. 2 Luminance



5. Viewing angle is the angle at which the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For Corporation er more information see FIG3.



#### FIG.3 Viewing Angle





### 4. Interface Specification

#### 4.1 Input power

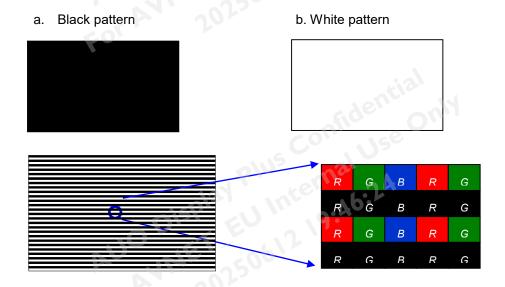
The P586ZVN01.0 module requires power inputs which are employed to power the LCD electronics and to drive the TFT array and liquid crystal.

Item		Symbol	Min.	Тур.	Max	Unit	Note
Power Supply Input Voltage	177	$V_{DD}$	10.8	12	13.2	V	1
	Black pattern		-	0.71	0.85	Α	
Power Supply Input Current	White pattern	I <sub>DD</sub>	-	0.72	0.87	Α	
	H-strip pattern		-	1.2	1.44	Α	
	Black pattern			8.51	10.22	Watt	2
Power Consumption	White pattern	Pc	fig.	8.61	10.34	Watt	
	H-strip pattern	Co,	15	14.33	17.2	Watt	
Inrush Current		I <sub>RUSH</sub>	3) V		4	Α	3

**Note1.** The ripple voltage should be fewer than 5% of VDD.

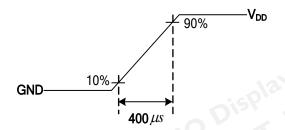
Note2. Test Condition:

- (1)  $V_{DD}$  = 12.0V, (2)  $F_V$  = 60Hz, (3) Fclk= 74.25MHz, (4) Temperature = 25  $^{\circ}$ C
- (5) Power dissipation check pattern. (Only for power design)



c. H-Strip pattern

**Note3.** Measurement condition : Rising time = 400us





### 4.2 Input Connection

### 4.2.1 Connector Type

TFT-LCD	Manufacturer	P-TWO	JAE	STARCONN
Connector	Part Number	187059-51221-1	EL DTE5107 HE	115E51-0000RA-M3-
Connector	Fait Number	10/059-51221-1	FI-RTESTSZ-FIF	R

### 4.2.2 Connector Pin Assignment

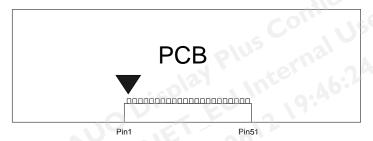
PIN#	Symbol	Description	Remark
1	VDD	Power +12V	1
2	VDD	Power +12V	
3	VDD	Power +12V	
4	VDD	Power +12V	
5	VDD	Power +12V	
6	VDD	Power +12V	
7	VDD	Power +12V	
8	VDD	Power +12V	
9	WP	Write Protection	3&5
10	SDA	SDA - I2C Serial Data	3&4
11	SCL	SCL - I2C Serial Clock	3&4
12	NC	No connection (for AUO test only. Do not connect)	2
13	NC	No connection (for AUO test only. Do not connect)	2
14	NC	No connection (for AUO test only. Do not connect)	2
15	NC	No connection (for AUO test only. Do not connect)	2
16	NC	No connection (for AUO test only. Do not connect)	2
17	GND	Ground	
18	1st Lane3_N	Negative eDP differential data input	
19	1st Lane3_P	Positive eDP differential data input	
20	GND	Ground	
21	1st Lane2_N	Negative eDP differential data input	
22	1st Lane2_P	Positive eDP differential data input	
23	GND	Ground	
24	1st Lane1_N	Negative eDP differential data input	
25	1st Lane1_P	Positive eDP differential data input	



27 28 29		Ground	
	1st Lane0_N	Negative eDP differential data input	
29	1st Lane0_P	Positive eDP differential data input	
	GND	Ground	
30	1st AUX_CH_P	Positive AUX Channel differential data input	
31	1st AUX_CH_N	Negative AUX Channel differential data input	
32	GND	Ground	
33	NC	No connection (for AUO test only. Do not connect)	2
34	GND	Ground	
35	2nd Lane3_N	Negative eDP differential data input	
36	2nd Lane3_P	Positive eDP differential data input	
37	GND	Ground	
38	2nd Lane2_N	Negative eDP differential data input	
39	2nd Lane2_P	Positive eDP differential data input	
40	GND	Ground	
41	2nd Lane1_N	Negative eDP differential data input	
42	2nd Lane1_P	Positive eDP differential data input	
43	GND	Ground	
44	2nd Lane0_N	Negative eDP differential data input	
45	2nd Lane0_P	Positive eDP differential data input	
46	GND	Ground	
47	2nd AUX_CH_P	Positive AUX Channel differential data input	
48	2nd AUX_CH_N	Negative AUX Channel differential data input	
49	GND	Ground	
50	HPD	Hot plug detection	
	NC	No connection (for AUO test only. Do not connect)  Corporation 2025 All Rights Reserved  Page 13 /	2



Note1. Pin number start from the left side as the following figure.



Note2. Please leave this pin unoccupied. It cannot be connected with any signal (Low/GND/High...).

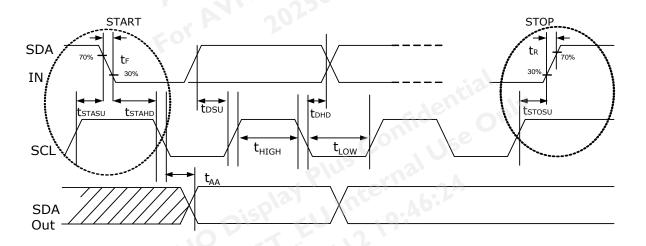
Note3. Input control signal threshold voltage definition

Item	Symbol	Min.	Тур.	Max.	Unit
Input High Threshold Voltage	VIH	2.7	-	3.6	V
Input Low Threshold Voltage	VIL	0	- A	0.6	V

Note4. I2C Data and Clock

#### I2C Data and Clock timing

	Parameter	Symbol	Min.	Тур.	Max	Unit
	SCL clock frequency	fSCL	-	ı	400	kHz
	Clock Pulse Width Low	tLOW	1.3	-	-	us
	Clock Pulse Width High	tHIGH	0.6	-	-	us
	Clock Low to Data Output Valid	tAA	-	-	1.1	us
	Start Setup Time	tSTASU	0.6	- ,	-	us
I2C	Start Hold Time	tSTAHD	0.6	1	-	us
	Stop Setup Time	tSTOSU	0.6	-	-	us
	Data In Setup Time	tDSU	0.2	-	-	us
	Data In Hold Time	tDHD	0	-	-	us
	SCL/SDA Rise Time	tR	-	-	0.3	us
	SCL/SDA Fall Time	tF	-	-	0.3	us

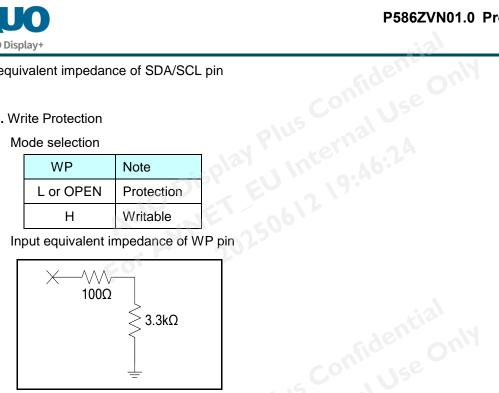




Input equivalent impedance of SDA/SCL pin

#### Note5. Write Protection

WP	Note
L or OPEN	Protection
Н	Writable





## 4.3 Input Data Format

### 4.3.1 eDP Data Format

1st Lane0	1st Lane1	1st Lane2	1st Lane3
R1-9:2	R2-9:2	R3-9:2	R4-9:2
R1-1:0lG1-9:4	R2-1:0lG2-9:4	R3-1:0lG3-9:4	R4-1:0IG4-9:4
G1-3:0IB1-9:6	G2-3:0IB2-9:6	G3-3:0IB3-9:6	G4-3:0IB4-9:6
B1-5:0IR5-9:8	B2-5:0IR6-9:8	B3-5:0IR7-9:8	B4-5:0IR8-9:8
R5-7:0	R6-7:0	R7-7:0	R8-7:0
G5-9:2	G6-9:2	G7-9:2	G8-9:2
G5-1:0IB5-9:4	-, G6-1:0IB6-9:4	G7-1:0IB7-9:4	G8-1:0IB8-9:4
B5-3:0IR9-9:6	B6-3:0IR10-9:6	B7-3:0IR11-9:6	B8-3:0IR12-9:6
R9-5:0IG9-9:8	R10-5:0IG10-9:8	R11-5:0lG11-9:8	R12-5:0IG12-9:8
G9-7:0	G10-7:0	G11-7:0	G12-7:0
B9-9:2	B10-9:2	B11-9:2	B12-9:2
B9-1:0IR13-9:4	B10-1:0IR14-9:4	B11-1:0IR15-9:4	B12-1:0IR16-9:4
R13-3:0IG13-9:6	R14-3:0IG14-9:6	R15-3:0IG15-9:6	R16-3:0IG16-9:6
G13-5:0IB13-9:8	G14-5:0IB14-9:8	G15-5:0IB15-9:8	G16-5:0IB16-9:8
B13-7:0	B14-7:0	B15-7:0	B16-7:0
	0, 6	74.	
	UU JET	06/1	
	1 47 02		

2nd Lane0	2nd Lane1	2nd Lane2	2nd Lane3
R1921-9:2	R1922-9:2	R1923-9:2	R1924-9:2
R1921-1:0lG1921-9:4	R1922-1:0lG1922-9:4	R1923-1:0lG1923-9:4	R1924-1:0lG1924-9:4
G1921-3:0IB1921-9:6	G1922-3:0IB1922-9:6	G1923-3:0IB1923-9:6	G1924-3:0IB1924-9:6
B1921-5:0IR1925-9:8	B1922-5:0IR1926-9:8	B1923-5:0IR1927-9:8	B1924-5:0IR1928-9:8
R1925-7:0	R1926-7:0	R1927-7:0	R1928-7:0
G1925-9:2	G1926-9:2	G1927-9:2	G1928-9:2
G1925-1:0IB1925-9:4	G1926-1:0IB1926-9:4	G1927-1:0IB1927-9:4	G1928-1:0IB1928-9:4
B1925-3:0IR1929-9:6	B1926-3:0IR1930-9:6	B1927-3:0IR1931-9:6	B1928-3:0IR1932-9:6
R1929-5:0IG1929-9:8	R1930-5:0IG1930-9:8	R1931-5:0IG1931-9:8	R1932-5:0IG1932-9:8
G1929-7:0	G1930-7:0	G1931-7:0	G1932-7:0
B1929-9:2	B1930-9:2	B1931-9:2	B1932-9:2
B1929-1:0IR1933-9:4	B1930-1:0IR1934-9:4	B1931-1:0IR1935-9:4	B1932-1:0IR1936-9:4
R1933-3:0IG1933-9:6	R1934-3:0IG1934-9:6	R1935-3:0IG1935-9:6	R1936-3:0IG1936-9:6
G1933-5:0IB1933-9:8	G1934-5:0IB1934-9:8	G1935-5:0IB1935-9:8	G1936-5:0IB1936-9:8
B1933-7:0	B1934-7:0	B1935-7:0	B1936-7:0
			O//.
		C.O., 11	5 <sup>©</sup> .
		1115	
-		rer	A



#### 4.3.2 Color Input Data Reference

The following table is for color versus input data (10bits). The higher the gray level, the brighter the color.10bits

												á	K		Col	or In	put (	ata			7.	À										
Color	Level		RED data (MSB:R9,LSB:R0)					GREEN data (MSB:G9,LSB:G0)					BLUE data (MSB:B9,LSB:B0)						Remark													
		R9	R8	R7	R6	R5	R4	R3	R2	R1	RO	G9	G8	G7	G6	G5	G4	G3	G2	G1	G0	В9	88	В7	В6	B5	В4	ВЗ	B2	В1	В0	
Black	-	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
White	-	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	
L511	-	0	1	1	1	1	1	1	1	1	1	0	1	1	1	1	1	1	1	1	1	0	1	1	1	1	1	1	1	1	1	
	LO	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
Red	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:		e.	:	:	:	:	:	:	:	:	
	L1023	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	LO	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
Green	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:		:	:			:	:	:	:	:	:	:	:	:	:	
	L1023	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	
	LO	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
Blue	:	:	:	:	:	:	:	:	:	1		:	:	:	:	:	:	9	:	:	:	:	:	:	:	:	:	:	:	:	:	
	L1023	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	



### 5. Signal Timing Specification

This is the signal timing required at the input of the user connector. All of the interface signal timing should be satisfied with the following specifications for its proper operation.

#### 5.1.1. Timing table

The input timing is shown as the following table.

Symbol	Descrip	tion	Min.	Тур.	Max.	Unit	Remark
Tv	For,	Period	1460	1530	1940	Th	
Tdisp (v)		Active	1440	1440	1440	Th	
Tblk (v)	Vertical Section	Blanking	20	90	500	Th	
Fv		Frequency	47	60	63	Hz	Note 3-4 Note 3-7
Th		Period	2720	2800	2880	Tclk	
Tdisp (h)	Horizontal	Active	2560	2560	2560	Tclk	
Tblk (h)	Section	Blanking	160	240	320	Tclk	
Fh	ko,	Frequency	89.7	91.8	97.2	kHz	Note 3-5
Tclk	Divol Clock	Period	3.78	3.89	4.098	ns	1/Fclk
Fclk	Pixel Clock	Frequency	244	257	264.5	MHz	Note 3-6
	Link Rate per L	ane	Co.	2.7		Gbps	

**Note 3-4:** The optimal Vertical Frequency is 60 ~ 63 Hz for best picture quality.

**Note 3-5:** The equation is listed as following. Please don't exceed the above recommended value.

```
Fh (Min.) = Fclk (Min.) / Th (Min.)
Fh (Typ.) = Fclk (Typ.) / Th (Typ.)
Fh (Max.) = Fclk (Max.) / Th (Min.)
```

**Note 3-6:** The equation is listed as following. Please don't exceed the above recommended value.

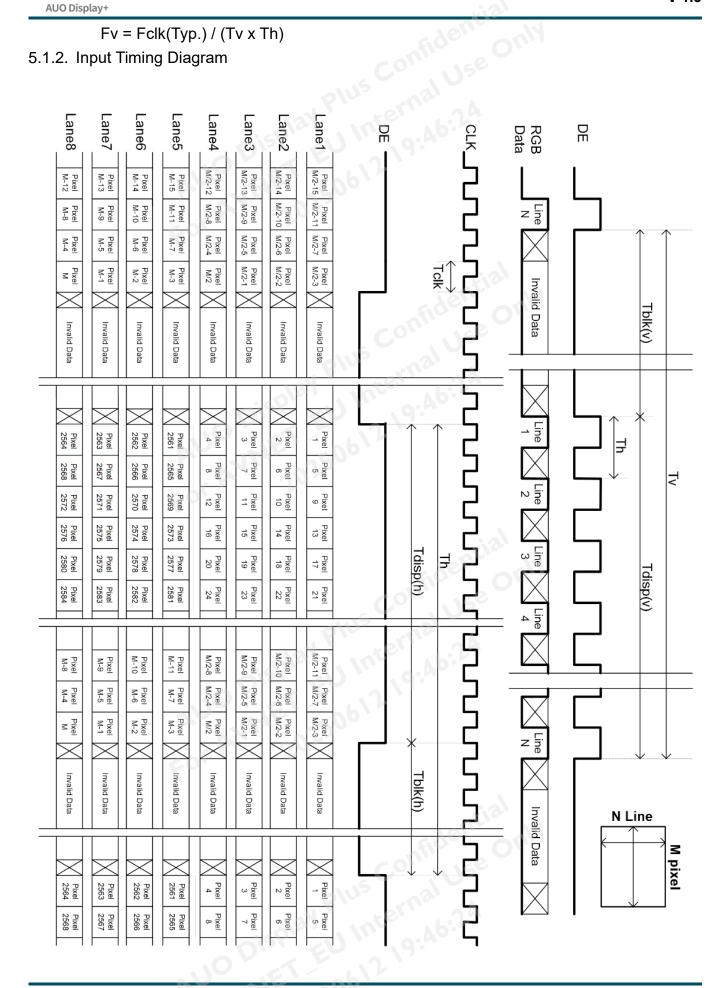
```
1st Lane N & 2nd Lane N skew < 200ns
Fclk (Typ.) = Fv (Typ.) x Th (Typ.) x Tv (Typ.)
Fclk (Min.) \leq Fv x Th x Tv \leq Fclk (Max.)
```

**Note 3-7:** The equation is listed as following. Please don't exceed the above recommended value.



### Fv = Fclk(Typ.) / (Tv x Th)

#### 5.1.2. Input Timing Diagram





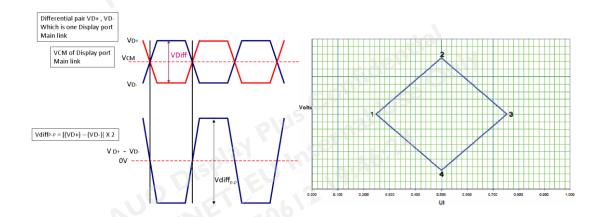
### 5.2 Input interface characteristics

eDP Specification (Follow as VESA DisplayPort Standard Version 1.2)

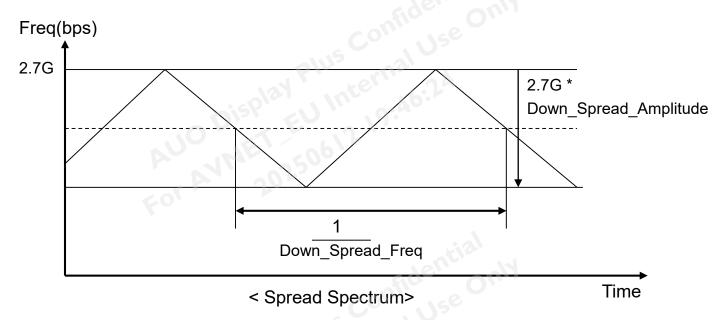
a. DisplayPort main link signal:

a. 2. 2 p. a. y . a. c	9				
	DisplayPort main link				
	-isplan I Inco . Ab.	Min	Тур	Max	unit
Frequency	Main link Frequency	-	2.7	-	Gbps
UI	Unit Interval	-	370	-	ps
VCM	RX input DC Common Mode Voltage	-	0	-	V
VDiff <sub>P-P</sub>	Peak-to-peak Voltage at a receiving Device	150	-	-	mV
Down_Spread_Freq	Link clock down spread frequency	30	-	33	KHz
Down_Spread_Amplitude	Link clock down spread amplitude	-	-	0.5	%

Point	Time(UI)	Voltage
1	0.245	0
2	0.5	75mV
3	0.755	0
4	0.5	-75mV

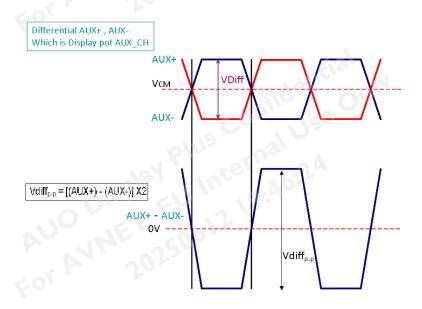






#### b. DisplayPort AUX\_CH signal:

	7 = 0				
	DisplayPort AUX_CH				
	Dispresulting: Add	Min	Тур	Max	unit
VCM	AUX DC Common Mode Voltage	0	-	2.0	V
VDiff <sub>P-P</sub>	AUX Peak-to-peak voltage at a receiving device	0.27	-	1.36	V



#### c. DisplayPort VHPD signal:

		DisplayPort VHPD				
		Com 115e	Min	Тур	Max	unit
VHPD	HPD Voltage	Plus mail	2.25	-	3.6	V



#### d. Intra-Pair skew

	LRX-SKEW-INTRA_PAIR				
	1115	Min	Тур	Max	unit
LRX-SKEW-	Long Intro mair Skow Talayana			E0	n 0
INTRA_PAIR	Lane Intra-pair Skew Tolerance	-	-	50	ps

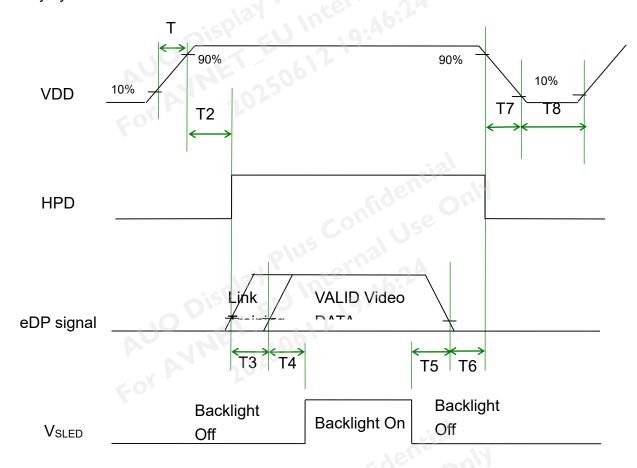
#### e. Inter-Pair Skew

	NU	LRX-SKEW-INTER_PAIR				
		VA 3053	Min	Тур	Max	unit
LRX-SKEW- INTER_PAIR	For	Lane-to-Lane Skew at RX package pins	-	-	5200	ps
		O Display Plus Confidential Use O			5200	



### 5.4 Power Sequence for LCD

VDD power,eDP signal and backlight on/off sequence are as following. eDP signals from any system shall be Hi-Z state when VDD is off.



### **Power Sequence Timing**

Symbol		Value	okus, o	Unit	Remark	
Symbol	Min.	Typ.	Max.	Oilit		
T1	0.5	ED	10	[ms]		
T2	6 W	2025061	550	[ms]	Sink device AUX CH must be operational upon HPD high.	
Т3	0	-	-	[ms]	Note 1	
T4	500	-	-	[ms]		
T5	100	-	-den	[ms]		
Т6	0	علىاء	200	[ms]	Note 2 Note 3	
Т7	0	play-	200	[ms]	Note 3 Note 4	



- Note 1 During T3 period, eDP link training time by customer's system.
- **Note 2:** Recommend setting T6 = 0ms to avoid electronic noise when VDD is off.
- Note 3: During T6 and T7 period, please keep the level of input eDP signals with Hi-Z state.
- Note 4: Voltage of VDD must decay smoothly after power-off.(customer system decide this value) 20250612 19:46:



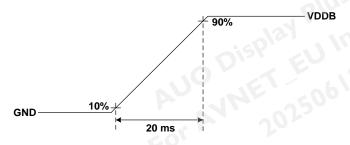
### 6. Backlight Specification

#### 6.1 Electrical specification

	Item	S	ymbol	Condition	Min	Тур	Max	Unit	Note
1	Power Supply Input Voltage	VDDB		12-	22.8	24	25.2	V	-
2	Power Supply Input Current	I <sub>DDB</sub>		VDDB=24V		4.7	5.24	Α	1
3	Power Consumption		P <sub>DDB</sub>	VDDB=24V		112.8	125.8	Watt	1
4	Inrush Current	Irush		VDDB=24V	4-1		16.3	Α	2
_	5 Control signal voltage	V	Hi	VDDB=24V	2	-nli	3.3	\  \  \  \  \  \  \  \  \  \  \  \  \	-
3		Vsignal	Low	VDDB-24V	0,0	-	8.0	V	3
6	Control signal current	Signal		VDDB=24V	-	-	1.5	mA	-
7	External PWM Duty ratio (input duty ratio)	D_EPWM		VDDB=24V	5	-	100	%	4
8	External PWM Frequency	F_EPWM		VDDB=24V	120	-	960	Hz	4
9	a BET III III		H	VDDB=24V	Ор	en Colled	ctor	V	5
9	DET status signal	DET	Lo	VDDB-24V	0	-	8.0	V	5
10	Input Impedance	Rin		VDDB=24V	300			Kohm	-
11	LED MTTF	Ľ	TLED	-	lent	50,000	-	Hr	6

Note 1: Dimming ratio= 100%, (Ta=25±5°C, Turn on for 45minutes)

Note 2: MAX input current while DB turn on, measurement condition VDDB rising time=20ms(VDDB: 10%~90%)



Note 3: When BLU off ( VDDB = 24V , VBLON = 0V) , IDDB (max) = 0.1A

Note 4: Less than 5% dimming control is functional well and no backlight shutdown happened

Note 5: Normal: 0~0.8V; Abnormal: Open collector

Note 6: The lifetime (MTTF) is defined as the time which luminance of LED is 50% compared to its original value.

[Operating condition: Continuous operating at Ta = 25±2°C, for single LED only]

MTTF is a reference index, it is not representative of warranty



#### 6.2 Input Pin Assignment

The P586ZV01.0 module requires [1 power input (14-pin)]

LED DB connector: CI0114M1HRL-NH(CviLux)

Pin	Symbol	Description	Note
1	VDDB	Power Supply Input Voltage	
2	VDDB	Power Supply Input Voltage	
3	VDDB	Power Supply Input Voltage	
4	VDDB	Power Supply Input Voltage	
5	VDDB	Power Supply Input Voltage	
6	GND	Ground	
7	GND	Ground	
8	GND	Ground	
9	GND	Ground	
10	GND	Ground	
11	DET	BLU status detection:	1
12	VBLON	BLU On-Off control:	2,3
13	NC	NC	4
14	PDIM	External PWM	2, 5

#### Note1. DET status

DET	BLU status
0 ~ 0.8V	Normal
Open collector	Abnormal

Recommend pull high R > 10K ohm, pull high voltage VDD = 3.3V

#### Note2. input control signal threshold voltage definition

Item	Symbol	Min.	Тур.	Max.	Unit
Input High Threshold Voltage	VIH	2	-	3.3	V
Input Low Threshold Voltage	VIL	0	-	0.8	V

#### Note3. VBLON

Mode selection

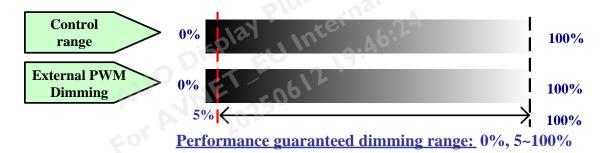
VBLON	Note
H or OPEN	BL On
L	BL Off

Note4. Please leave this pin unoccupied. It cannot be connected by any signal (Low/GND/High).



#### Note5. PDIM

PWM Dimming range:

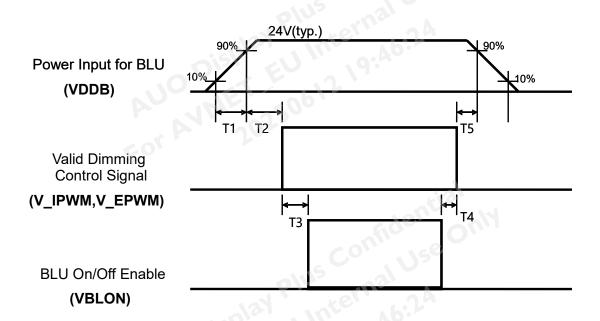


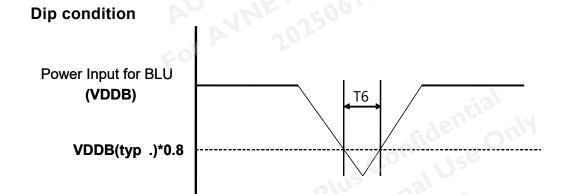
External PWM function dimming ratio 0%~100%, Judge condition as below:

- (1) Backlight module must be lighted ON normally.
- (2) All protection function must work normally.
- (3) Uniformity and flicker could be guaranteed at External PWM function dimming ratio 5%~100%



#### 6.3 Power Sequence for Backlight





Parameter	Min	Тур	Max	Units
T1	20	_	-	ms *1
T2	0	-	-	ms
T3	300			ms
T4	300	-	-12	ms
T5	0	-	Yeu	ms
T6		00	1000	ms <sup>*2</sup>

Note:1. T6 describes VDDB dip condition and VDDB couldn't lower than 10% VDDB.



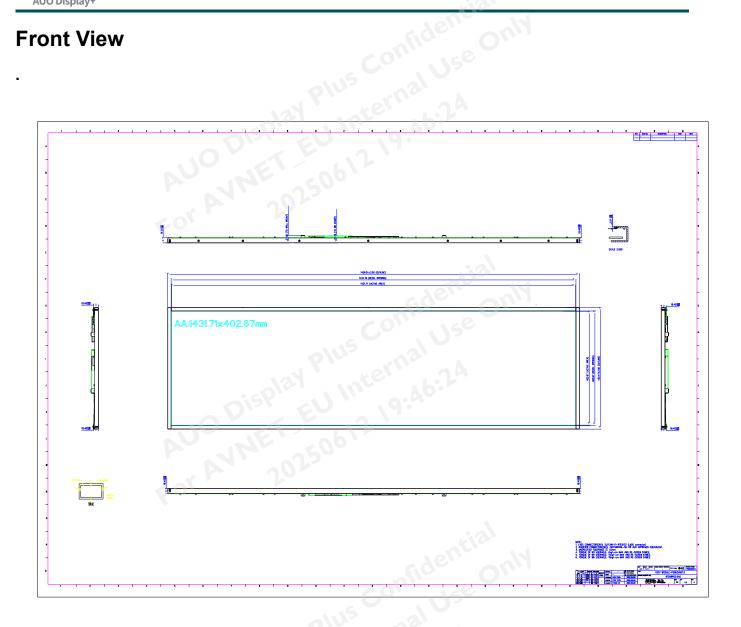
### 7. Mechanical Characteristics

The contents provide general mechanical characteristics for the model P586ZV01.0. In addition, the figures in the 19:46:2 next page are detailed mechanical drawing of the LCD.

I	tem	Dimension	Unit	Note		
	Horizontal	1459.51	mm			
	Vertical	430.47	mm			
	Depth (Dmin)	10.7	mm	Front bezel to Back Bezel		
Outline Dimension	Depth (Dmax)	27	mm	Front Bezel to BOSS		
	Bezel opening	1434.7x405.67	mm			
	Bezel Width	12.4/12.4/12.4/12.4	mm	U/D/L/R		
	Display Area	1431.71 (H) x 402.67 (V)	mm			
Weight	9	.05	Kg			
		Plus Confident				



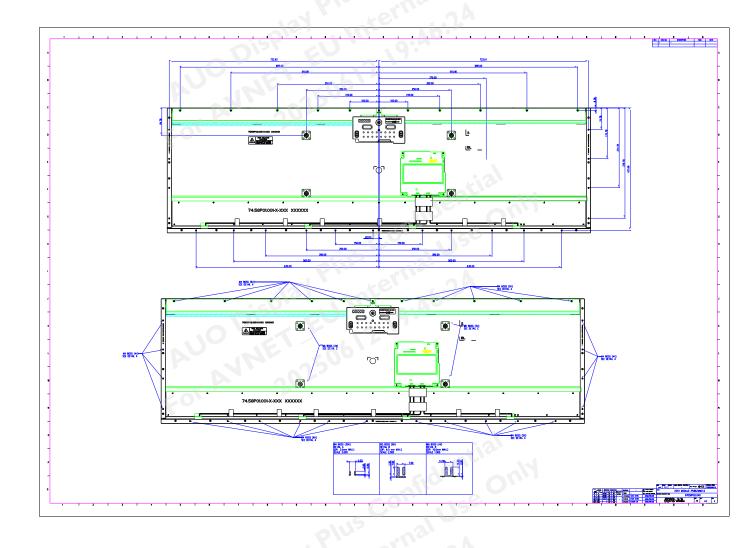
### **Front View**





#### **Back View**

This Drawing is subject to be changed after project kicking off.





### 8. Reliability Test Items

Test Item	Q'ty	Condition
High temperature storage test	3	60°C, 500hrs
Low temperature storage test	3	-20°C, 500hrs
High temperature operation test	3	60°C, 500hrs
Low temperature operation test	3	-20°C, 500hrs
Vibration test (With carton)	1( PKG)	Random wave (1.04Grms 2~200Hz)  Duration : X,Y,Z 20min per axes
Drop test (With carton)	1( PKG)	Height: 20.0cm Direction: Bottom flat two times ∘ (ASTMD4169-I)
MTBF  AUO DISPIS	12	50°C/80%, 1300hrs, 90% confidence level



### 9. International Standard

#### 9.1 Safety

- (1) UL 62368-1: Audio/video, information and communication technology equipment Part 1: Safety requirements
- (2) IEC 62368-1: Audio/video, information and communication technology equipment -Part 1: Safety requirements
- (3) EN 62368-1: Audio/video, information and communication technology equipment -Part 1: Safety requirements

#### 9.2 EMC

- (1) ANSI C63.4 "Methods of Measurement of Radio-Noise Emissions from Low-Voltage Electrical and Electrical Equipment in the Range of 9kHz to 40GHz. "American National standards Institute(ANSI), 1992
- (2) C.I.S.P.R "Limits and Methods of Measurement of Radio Interface Characteristics of Information Technology Equipment." International Special committee on Radio Interference.
- (3) EN 55022 "Limits and Methods of Measurement of Radio Interface Characteristics of Information Technology Equipment." European Committee for Electrotechnical Standardization. (CENELEC), 1998

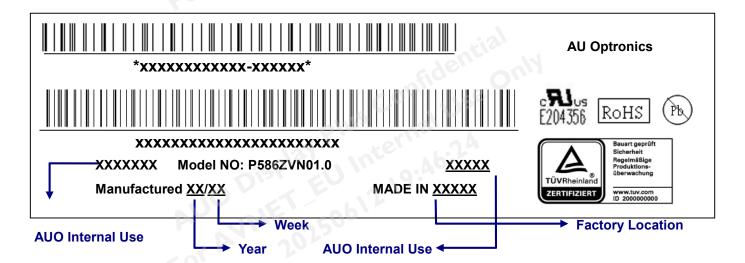


### 10. Packing

#### 10.1 Definition of Label

#### A. Panel Label:





#### **Green mark description**

- (1) For Pb Free Product, AUO will add for identification.
- (2) For RoHs compatible products, AUO will add RoHS for identification.

Note: The green Mark will be present only when the green documents have been ready by AUO internal green team. (definition of green design follows the AUO green design checklist.)

#### **B. Carton Label:**

The label is on the carton as shown below: (Example)

AUO Display Plus
MODEL NO: P586ZVN01.0
PART NO: 97D58PXX.0XX
AUO Corporation
MODEL NO: P586ZVN01.0
PART NO: 97.58PXX.0XX

CUSTOMER NO: XXXXXX-XXXXXX

CARTON NO:

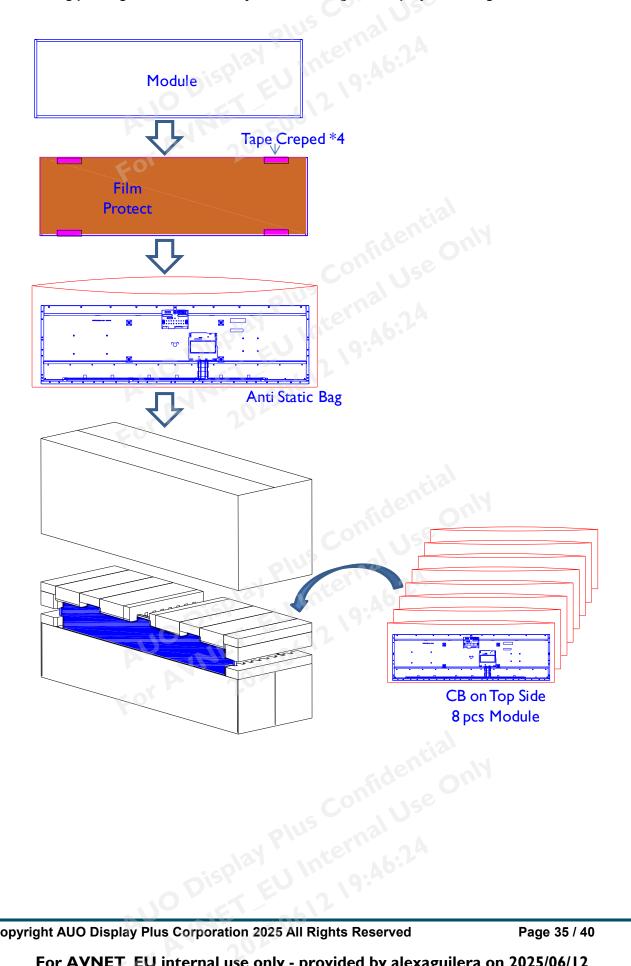
Made in XXXXXX

\*XXXXX-XXXXXXXXX\*



#### 10.2 **Packing Methods**

This following packing information is subject to be changed after project kicking off.

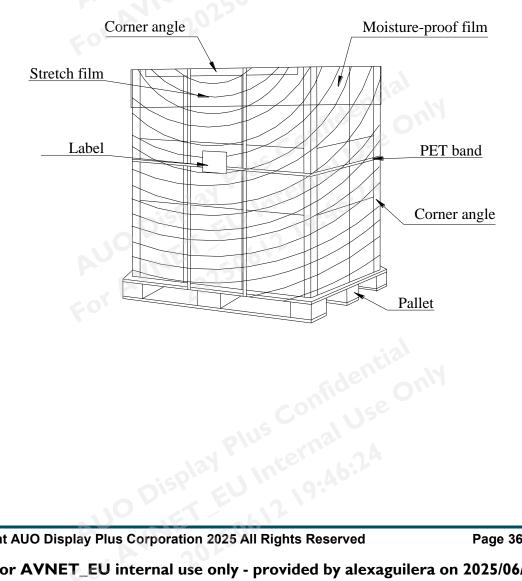




#### **Pallet and Shipment Information** 10.3

This following packing information is subject to be changed after project kicking off.

	Itom		Packing			
	Item	Qty. Dimension		Weight (kg)	Remark	
1	Packing Box	8 pcs/box	1640(L)mm*545 (W)mm*535(H)mm	78.6	Panel 9.2kg	
2	Pallet	1	1660(L)mm*1150(W)mm*145(H)mm 26 F		Pallet	
3	Boxes per Pallet	2 boxes/Pa				
4	Panels per Pallet	16 pcs/Pal	Air and Sea >  Double pallet			
_	Pallet	2pallet (by Air)	1660(L)mm*1150(W)mm*1370 (H)mm	366.4 (by Air)	Davida mallat	
5	after packing	2pallet (by Sea)	1660(L)mm*1150(W)mm*1370(H)mm	366.4 (by Sea)	Double pallet	





#### 11. Precautions

Please pay attention to the followings when you use this TFT LCD module.

#### 11.1. Mounting Precautions

- (1) You must mount a module using holes arranged in four corners or four sides.
- (2) You should consider the mounting structure so that uneven force (ex. twisted stress) is not applied to module. And the case on which a module is mounted should have sufficient strength so that external force is not transmitted directly to the module.
- (3) Please attach the surface transparent protective plate to the surface in order to protect the polarizer. Transparent protective plate should have sufficient strength in order to the resist external force.
- (4) You should adopt radiation structure to satisfy the temperature specification.
- (5) Acetic acid type and chlorine type materials for the cover case are not desirable because the former generates corrosive gas of attacking the polarizer at high temperature and the latter cause circuit broken by electro-chemical reaction.
- (6) Do not touch, push or rub the exposed polarizer with glass, tweezers or anything harder than HB pencil lead. And please do not rub with dust clothes with chemical treatment. Do not touch the surface of polarizer for bare hand or greasy cloth. (Some cosmetics are detrimental to the polarizer.)
- (7) When the surface becomes dusty, please wipe gently with absorbent cotton or other soft materials like chamois soaks with petroleum benzene. Normal-hexane is recommended for cleaning the adhesives used to attach front/ rear polarizer. Do not use acetone, toluene and alcohol because they cause chemical damage to the polarizer.
- (8) Wipe off saliva or water drops as soon as possible. Their long time contact with polarizer causes deformations and color fading.
- (9) Do not open the case because inside circuits do not have sufficient strength.

#### 11.2. Operating Precautions

- (1) The spike noise causes the mis-operation of circuits. It should be lower than following voltage: V=±200mV(Over and under shoot voltage)
- (2) Response time depends on the temperature. (In lower temperature, it becomes longer.)
- (3) Brightness depends on the temperature. (In lower temperature, it may become lower.) And in lower temperature, response time (required time that brightness is stable after turned on) becomes longer.
- (4) Be careful for condensation at sudden temperature change. Condensation makes damage to polarizer or electrical contacted parts. And after fading condensation, smear or spot will occur.
- (5) When fixed patterns are displayed for a long time, remnant image is likely to occur.
- (6) Module has high frequency circuits. Sufficient suppression to the electromagnetic



interference shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interface.

(7) The conductive material and signal cables are kept away from LED driver inductor to prevent abnormal display, sound noise and temperature rising.

#### 11.3. Operating Condition for Public Information Display

The device listed in the product specification is designed and manufactured for PID (Public Information Display) application. To optimize module's lifetime and function, below operating usages are required.

- (1) Normal operating condition
  - A. Operating temperature: -20~60°C
  - B. Operating humidity: 10~90%
  - C. Display pattern: dynamic pattern (Real display).Note) Long-term static display would cause image sticking.
- (2) Operation usage to protect against image sticking due to long-term static display.
  - A. Suitable operating time: under 24 hours a day
  - B. Liquid Crystal refresh time is required. Cycling display between 5 minutes' information (static) display and 10 seconds' moving image.
  - C. Periodically change background and character (image) color.
  - D. Avoid combination of background and character with large different luminance.
- (3) Periodically adopt one of the following actions after long time display.
  - A. Running the screen saver (motion picture or black pattern)
  - B. Power off the system for a while
- (4) LCD system is required to place in well-ventilated environment. Adapting active cooling system is highly recommended.
- (5) Product reliability and functions are only guaranteed when the product is used under right operation usages. If product will be used in extreme conditions, such as high temperature/ humidity, display stationary patterns, or long operation time etc..., it is strongly recommended to contact AUO for filed application engineering advice. Otherwise, its reliability and function may not be guaranteed. Extreme conditions are commonly found at airports, transit stations, banks, stock market and controlling systems.

#### 11.4. Electrostatic Discharge Control

Since a module is composed of electronic circuits, it is not strong to electrostatic discharge. Make certain that treatment persons are connected to ground through wristband etc. And don't touch interface pin directly.



#### 11.5. Precautions for Strong Light Exposure

- (1) Strong light exposure causes degradation of polarizer and color filter.
- (2) To keep display function well as a digital signage application, especially the component of TFT is very sensitive to sunlight, it is necessary to set up blocking device protecting panel from radiation of ambient environment.

#### 11.6. Storage

When storing modules as spares for a long time, the following precautions are necessary.

- (1) Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keep the temperature between 5°C and 35°C at normal humidity.
- (2) The polarizer surface should not come in contact with any other object. It is recommended that they be stored in the container in which they were shipped.
- (3) Storage condition is guaranteed under packing conditions.
- (4) The phase transition of Liquid Crystal in the condition of the low or high storage temperature will be recovered when the LCD module returns to the normal condition.

#### 11.7. Handling Precautions for Protection Film

- (1) The protection film is attached to the bezel with a small masking tape. When the protection film is peeled off, static electricity is generated between the film and polarizer. This should be peeled off slowly and carefully by people who are electrically grounded and with well ionblown equipment or in such a condition, etc.
- (2) When the module with protection film attached is stored for a long time, sometimes there remains a very small amount of glue still on the bezel after the protection film is peeled off.
- (3) You can remove the glue easily. When the glue remains on the bezel or its vestige is recognized, please wipe them off with absorbent cotton waste or other soft material like chamois soaked with normal-hexane.

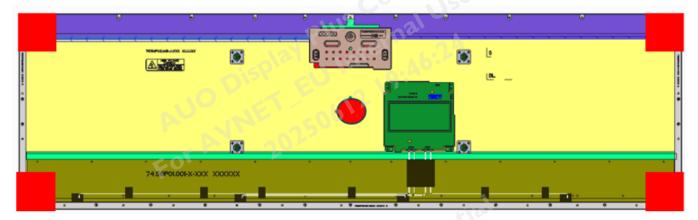
#### 11.8. Dust Resistance

- (1) AUO module dust test is conducted with marked holes (see Figure 1) sealed to comply with JIS D0207.
- (2) Module users should design set with these holes used/sealed (if not used) or covered by set mechanism to prevent dust from entering. The AUO testing procedure cannot replicate all different real world scenarios, module users should apply set dust resistance solution to meet users' requirement.



Figure 1

Step1: to seal the holes and concerns on the position of red mark



Step2: to seal the slits around the front bezel and back cover on the position of brown mark.

